

Title (en)  
ECO-FRIENDLY SOLDERABLE WIRE ENAMEL

Title (de)  
UMWELTFREUNDLICHER LÖTBARER DRAHTLACK

Title (fr)  
VERNIS ISOLANT BRASABLE RESPECTUEUX DE L'ENVIRONNEMENT

Publication  
**EP 2398837 B1 20130710 (DE)**

Application  
**EP 10706172 A 20100201**

Priority  
• EP 2010051182 W 20100201  
• DE 102009003512 A 20090220

Abstract (en)  
[origin: WO2010094556A1] The present invention relates to polyurethane wire enamels composed of: A) 10% - 60%, preferably 20% - 50%, more preferably 25% - 45%, by weight of at least one blocked polyisocyanate adduct blocked with alkylphenols, B) 4% - 30%, preferably 7% - 25%, more preferably 9% - 20%, by weight of at least one hydroxy polyester containing ester groups and/or imide groups and/or amide groups, C) 20% - 70%, preferably 30% - 60%, more preferably 35% - 45%, by weight of organic, hydrocarbon-based solvents, D) 1% - 20%, preferably 5% - 18%, more preferably 10% - 16%, by weight of further auxiliaries and additives, the sum of components A)+B)+C)+D) adding up to 100% by weight, and to processes for producing them, and to their use.

IPC 8 full level  
**C08G 18/42** (2006.01); **C08G 18/80** (2006.01); **C09D 175/04** (2006.01); **C09D 175/06** (2006.01); **C09D 175/12** (2006.01); **H01B 3/30** (2006.01)

CPC (source: EP KR US)  
**C08G 18/42** (2013.01 - EP KR US); **C08G 18/8067** (2013.01 - EP KR US); **C08L 75/04** (2013.01 - KR); **C09D 175/04** (2013.01 - EP KR US); **C09D 175/06** (2013.01 - EP US); **C09D 175/12** (2013.01 - EP US); **H01B 3/302** (2013.01 - EP KR US); **H01B 3/308** (2013.01 - EP KR US); **H01B 3/423** (2013.01 - EP KR US)

Designated contracting state (EPC)  
AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HR HU IE IS IT LI LT LU LV MC MK MT NL NO PL PT RO SE SI SK SM TR

DOCDB simple family (publication)  
**WO 2010094556 A1 20100826**; BR PI1012341 A2 20160322; CN 102325817 A 20120118; CN 102325817 B 20140402; DE 102009003512 A1 20100902; EP 2398837 A1 20111228; EP 2398837 B1 20130710; ES 2425775 T3 20131017; JP 2012518876 A 20120816; JP 5679998 B2 20150304; KR 101727188 B1 20170426; KR 20110119811 A 20111102; MX 2011008474 A 20111118; MY 155291 A 20150930; TW 201037044 A 20101016; TW I486410 B 20150601; US 2012045571 A1 20120223; US 9109079 B2 20150818

DOCDB simple family (application)  
**EP 2010051182 W 20100201**; BR PI1012341 A 20100201; CN 201080008315 A 20100201; DE 102009003512 A 20090220; EP 10706172 A 20100201; ES 10706172 T 20100201; JP 2011550505 A 20100201; KR 20117021964 A 20100201; MX 2011008474 A 20100201; MY PI2011003818 A 20100201; TW 99104901 A 20100212; US 201013201235 A 20100201